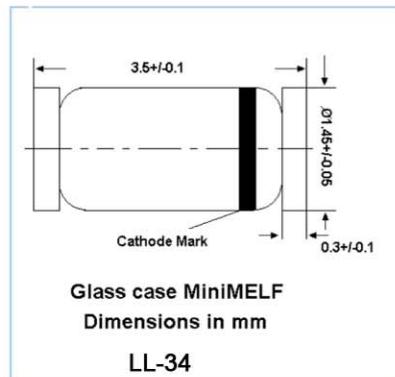


Fast switching diode in MiniMELF case especially suited
Silicon Epitaxial Planar Switching Diode

for automatic surface mounting



Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

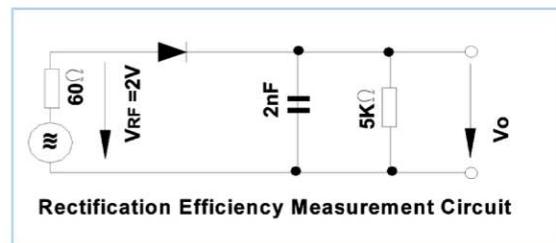
| Parameter | Symbol | Value | Unit |
|----------------------------------------------------------------------------------------------------------------------|-------------|-------------------|------|
| Peak Reverse Voltage | V_{RM} | 100 | V |
| Reverse Voltage | V_R | 75 | V |
| Average Rectified Forward Current | $I_{F(AV)}$ | 200 | mA |
| Non-repetitive Peak Forward Surge Current at $t = 1 \text{ s}$ at $t = 1 \text{ ms}$ at $t = 1 \mu\text{s}$ | I_{FSM} | 0.5 1 4 | A |
| Power Dissipation | P_{tot} | 500 ¹⁾ | mW |
| Junction Temperature | T_j | 175 | °C |
| Storage Temperature Range | T_{stg} | - 65 to + 175 | °C |

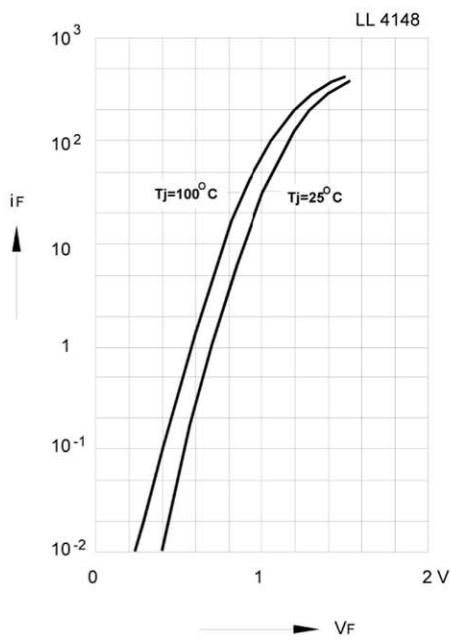
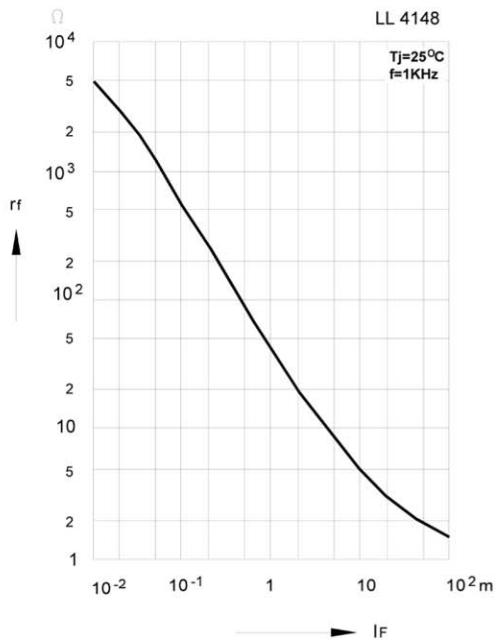
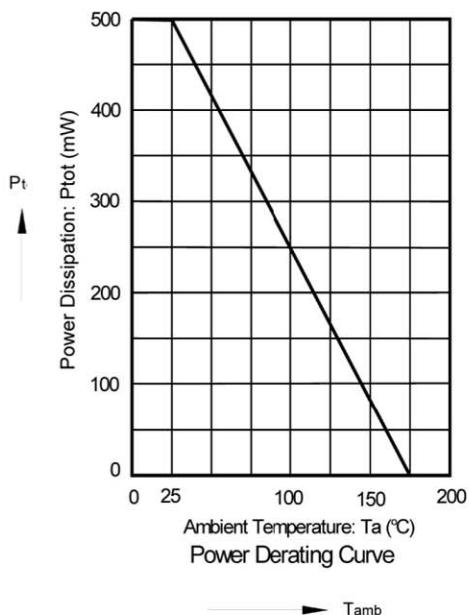
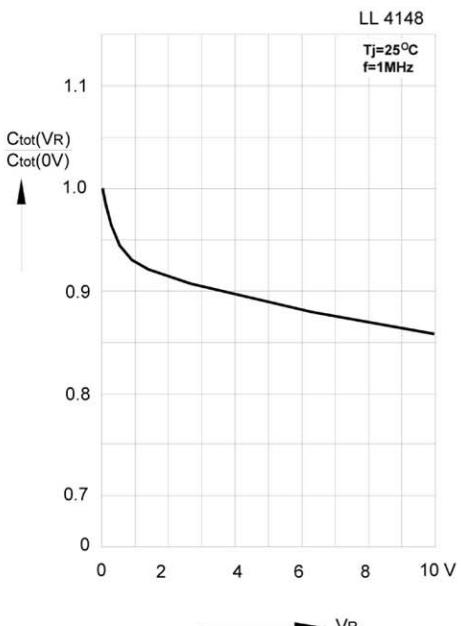
¹⁾ Valid provided that electrodes are kept at ambient temperature.

Characteristics at $T_a = 25^\circ\text{C}$

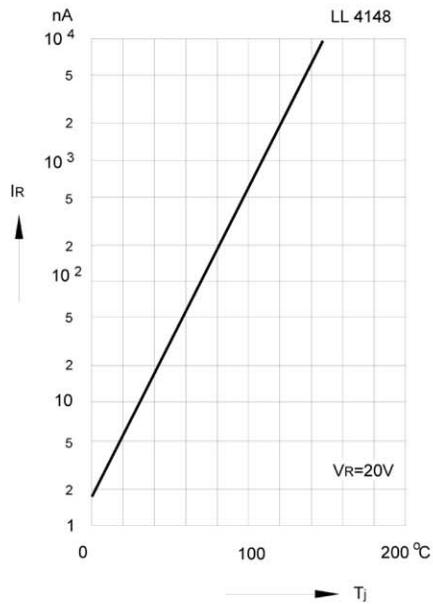
| Parameter | Symbol | Min. | Max. | Unit |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|------|--------------------|---------------|
| Forward Voltage at $I_F = 10 \text{ mA}$ | V_F | - | 1 | V |
| Leakage Current at $V_R = 20 \text{ V}$ at $V_R = 75 \text{ V}$ at $V_R = 20 \text{ V}, T_j = 150^\circ\text{C}$ | I_R | - | 25 | nA |
| | I_R | - | 5 | μA |
| | I_R | - | 50 | μA |
| Reverse Breakdown Voltage tested with 100 μA Pulses | $V_{(\text{BR})R}$ | 100 | - | V |
| Capacitance at $V_R = 0, f = 1 \text{ MHz}$ | C_{tot} | - | 4 | pF |
| Voltage Rise when Switching ON tested with 50 mA Forward Pulses $t_p = 0.1 \text{ s}$, Rise Time < 30 ns, $f_p = 5 \text{ to } 100 \text{ KHz}$ | V_{fr} | - | 2.5 | V |
| Reverse Recovery Time at $I_F = 10 \text{ mA}$ to $I_R = 1 \text{ mA}, V_R = 6 \text{ V}, R_L = 100 \Omega$ | t_{rr} | - | 4 | ns |
| Thermal Resistance Junction to Ambient Air | R_{thA} | - | 0.35 ¹⁾ | K/mW |
| Rectification Efficiency at $f = 100 \text{ MHz}, V_{RF} = 2 \text{ V}$ | η_V | 0.45 | - | - |

¹⁾ Valid provided that electrodes are kept at ambient temperature.



Forward characteristics

**Dynamic forward resistance
versus forward current**

**Admissible power dissipation
versus ambient temperature**
 Valid provided that electrodes are kept at ambient temperature

**Relative capacitance
versus reverse voltage**


Leakage current
versus junction temperature



Admissible repetitive peak forward current versus pulse duration
Valid provided that electrodes are kept at ambient temperature

